This version: Mar. 1999

# **OKI** Semiconductor

## **MSM9564**

#### IC for FM Multiplex Data Demodulation

#### **GENERAL DESCRIPTION**

The MSM9564 is an IC which demodulates FM character multiplex signals in the DARC (Data Radio Channel)<sup>\*1</sup> format to obtain digital data. The MSM9564 operates at 5 V.

The MSM9564 contains on one chip a band pass filter using a switched capacitor filter (SCF) and a group of circuits including frame memory, a frame synchronization circuit, and an error correction circuit.

By connecting an external FM receiver and memory for temporary data storage, and microcontroller, a system for obtaining digital data can easily be constructed.

The FM multiplex demodulation ICs, the MSM9500-series devices, are configured with minimum functions; so they will, by changing the software of the external microcontroller, be able to respond flexibly to the many FM multiplex broadcast services that are going to come about in the future.

The MSM9564 is best suited to radios and information processing devices that support DARC FM multiplex broadcasting. It is also best suited to car radios and car navigation systems that support VICS (Vehicle Information and Communication System), which started its service in 1996.

\*1 DARC is a registered trademark of NHK Engineering Services.

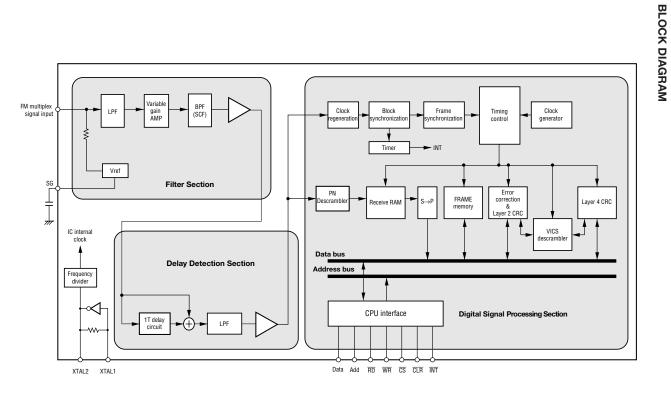
Any manufacturer who has a contract with NHK Engineering Services can produce and sell electronic equipment utilizing the DARC technology.

Any manufacturer who has a contract with NHK Engineering Services and VICS Center can produce and sell electronic equipment utilizing the VICS technology.

#### **FEATURES**

- Built-in VICS-supporting descrambler
- Built-in two receive channels including main channel and sub-channel (receives both VICS and D-GPS simultaneously)
- Pin compatible with MSM9552/MSM9554
- Internal frame memory enables automatic error correction.
- Built-in bandpass filter (SCF)
- Built-in block synchronization circuit and frame synchronization circuit
- Setting of the number of synchronization protection steps can be changed.
- Data clocks are regenerated by digital PLL.
- 1T delay detection
- Built-in vertical and horizontal error correction circuits
- Built-in layer 4 and layer 2 CRC processing circuits
- Parallel interface with microcontroller
- Clock output for external devices (64 kHz to 8.192 MHz variable)
- Compatible with the international standard frame formats A (real time block also supported), B, C
- Power supply:  $5 V \pm 10\%$
- Package:

44-pin plastic QFP (QFP44-P-910-0.80-2K) (Product name: MSM9564GA)

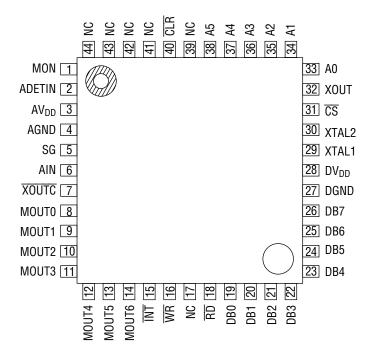


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3/10

#### **PIN CONFIGURATION (TOP VIEW)**



NC : No-connection pin

44-Pin Plastic QFP

#### **PIN DESCRIPTIONS**

Function	Pin	Symbol	Туре	Description		
Microcontroller	16	WR	I	Write signal to internal register.		
Interface	18	RD	I	Read signal to internal register.		
	15	ĪNT	0	Interrupt signal to microcontroller. "L": An interrupt is generated.		
	31	CS	Ι	Chip select signal. "L": Read, write, and data bus signals become active.		
	40	CLR	Ι	"L" : the internal registers are initialized and the device enter power down mode.		
	33 to 38	A0 to A5	I	Address signal to internal register.		
	19 to 26	DB0 to DB7	I/0	Data bus signal to internal register.		
Tuner	6	AIN	I	FM multiplex signal input.		
Interface	5	SG	0	Analog reference voltage output pin. Connect a capacitor between this pin and analog ground to prevent noise.		
Analog Section Test	1	MON	0	Analog section waveform monitoring pin. The analog blo mode setting is specified by the analog control register.		
	2	ADETIN	I	Digital signal input pin for testing analog section.		
Digital Section Test	8 to 14	MOUTO to MOUT6	0	Digital section test signal output and monitor output pins.		
Clock	29	XTAL1	I	8.192 MHz crystal connection pin.		
	30	XTAL2	0	8.192 MHz crystal connection pin.		
-	32	XOUT	0	Pin for supply of 64 kHz to 8.192 MHz variable clock to the outside.		
	7	XOUTC	Ι	XOUT output control pin. "L" = Clock output, "H" = Output disabled. Pulled up internally.		
Power Supply	3	AV <sub>DD</sub>	—	Analog section power supply pin.		
-	4	AGND	—	Analog ground pin.		
	28	DV <sub>DD</sub>	_	Digital section power supply pin.		
	27	DGND	_	Digital ground pin.		

#### **ABSOLUTE MAXIMUM RATINGS**

Parameter	Symbol	Condition	Rating	Unit	
Power Supply Voltage	AV <sub>DD</sub>		0.2 to .7.0		
Power Supply Voltage	DV <sub>DD</sub>	$AV_{DD} = DV_{DD}$	-0.3 to +7.0	V	
Input Voltage	VI	Ta = 25°C	-0.3 to AV <sub>DD</sub> + 0.3		
Output Voltage	V <sub>0</sub>		-0.3 to DV <sub>DD</sub> + 0.3		
Mauinauna Dauran Diasinatian	D	Ta = 25°C, per package	400	mW	
Maximum Power Dissipation	PD	Ta = 25°C, per output	50		
Storage Temperature	T <sub>STG</sub>	_	-55 to +150	°C	

#### **RECOMMENDED OPERATING CONDITIONS**

Parameter	Symbol	Condition	Range	Unit	Applied Pin
Power Supply Voltage	AV <sub>DD</sub>	AVnn = DVnn	4.5 to 5.5	V	AV <sub>DD</sub>
Power Supply Voltage	DV <sub>DD</sub>	AvDD = DvDD	4.0 10 0.0	v	DV <sub>DD</sub>
Crystal Oscillation Frequency	f <sub>XTAL</sub>		8.192 MHz ±100 ppm		XTAL1,
Crystal Oscillation Frequency			0.192 WHZ ±100 pp11		XTAL2
		Variable amplifier gain: $\times$ 1	1.33 to 2.0		A 181
FM Multiplex Signal Input	V <sub>AIN</sub> *	Variable amplifier gain: $\times$ 1.5	1.0 to 1.32	V	
Voltage		Variable amplifier gain: $\times 2$	0.66 to 1.0		AIN
		Variable amplifier gain: $\times 3$	0.5 to 0.65		
Operating Temperature	T <sub>op</sub>	—	-40 to +85	°C	

\* Peak values (a total voltage of the following signals (a) to (c)) of composite signals including multiplex signals.

(a) Voice signals (100% modulated: voice max.)

(b) Pilot signal

(c) FM multiplex signals (10%: LMSK max.)

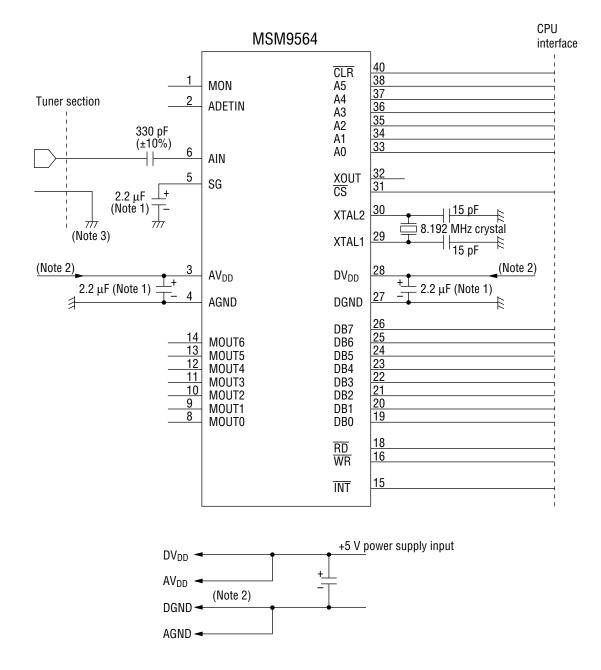
The maximum amplitude of an input signal is in the range of 2.0  $V_{P\mbox{-}P}$  in which the internal IC circuit is not saturated.

Therefore, multiplex signals of up to  $2.0 V_{P-P}$  can be input if only multiplex signals (excluding composite signals) are input from a signal generator.

### **ELECTRICAL CHARACTERISTICS**

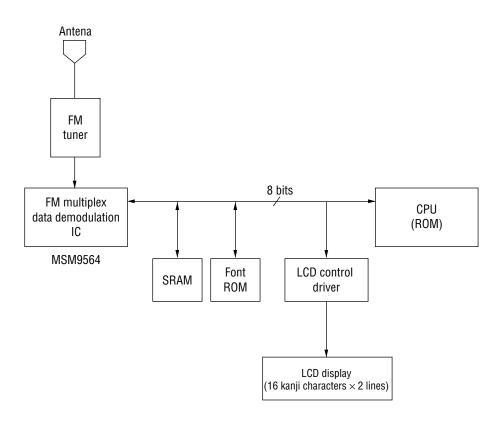
		$(DV_{DD} = AV_{DD} = 5 V \pm 10\%, D$	GND =	= AGN	D = 0 V	/, Ta =	–40 to +85°C)
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit	Applied Pin
Cumply Current		When operating, no load f = 8.192 MHz	_	18	34	mA	AV <sub>DD</sub> , DV <sub>DD</sub>
Supply Current	I <sub>DD</sub>	When in power down mode, no load	_	_	50	μA	
BPF Pass Band Attenuation	GAIN1	72 to 80 kHz Variable gain amplifier gain: 0 dB	_		3.0	dB	MON
BPF Stop Band Attenuation	GAIN2	0 to 53 kHz Variable gain amplifier gain: 0 dB	50		_	dB	MON
BPF Stop Band Attenuation	GAIN3	100 to 500 kHz Variable gain amplifier gain: 0 dB	50			dB	MON

#### EXTERNAL CONNECTION EXAMPLE

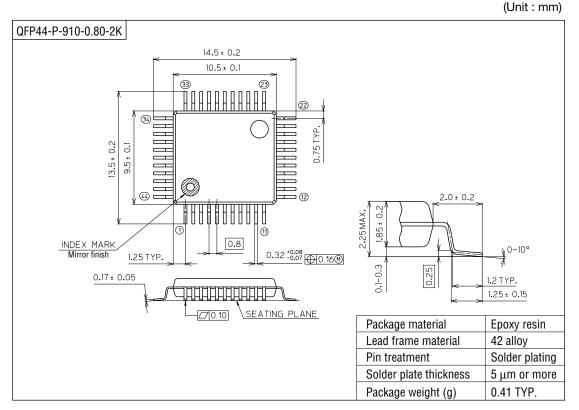


- (Note 1) Use a tantalum capacitor.
- (Note 2) The AV<sub>DD</sub> and DV<sub>DD</sub> should have different paths, respectively.
- (Note 3) The AGND and tuner ground should use the same ground.

#### **APPLICATION CIRCUIT EXAMPLE**



#### PACKAGE DIMENSIONS



Notes for Mounting the Surface Mount Type Package

The SOP, QFP, TSOP, TQFP, LQFP, SOJ, QFJ (PLCC), SHP, and BGA are surface mount type packages, which are very susceptible to heat in reflow mounting and humidity absorbed in storage. Therefore, before you perform reflow mounting, contact Oki's responsible sales person on the product name, package name, pin number, package code and desired mounting conditions (reflow method, temperature and times).

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Printed in Japan